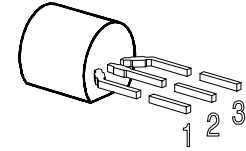


### SIPMOS® Small-Signal Transistor

- P channel
- Enhancement mode
- Logic Level
- $V_{GS(th)} = -0.8 \dots -2.0 \text{ V}$



| Pin 1 | Pin 2 | Pin 3 |
|-------|-------|-------|
| S     | G     | D     |

| Type    | $V_{DS}$ | $I_D$   | $R_{DS(on)}$ | Package | Marking |
|---------|----------|---------|--------------|---------|---------|
| BSS 110 | -50 V    | -0.17 A | 10 $\Omega$  | TO-92   | SS 110  |

| Type    | Ordering Code | Tape and Reel Information |
|---------|---------------|---------------------------|
| BSS 110 | Q62702-S500   | E6288                     |
| BSS 110 | Q62702-S278   | E6296                     |
| BSS 110 | Q67000-S568   | E6325                     |

### Maximum Ratings

| Parameter   | Symbol      | Values   | Unit |
|---|-------------|----------|------|
| Drain source voltage  | $V_{DS}$    | -50      | V    |
| Drain-gate voltage<br>$R_{GS} = 20 \text{ k}\Omega$           | $V_{DGR}$   | -50      |      |
| Gate source voltage   | $V_{GS}$    | $\pm 20$ |      |
| Continuous drain current<br>$T_A = 35 \text{ }^\circ\text{C}$ | $I_D$       | -0.17    | A    |
| DC drain current, pulsed<br>$T_A = 25 \text{ }^\circ\text{C}$ | $I_{Dpuls}$ | -0.68    |      |
| Power dissipation<br>$T_A = 25 \text{ }^\circ\text{C}$        | $P_{tot}$   | 0.63     | W    |

## Maximum Ratings

| Parameter   | Symbol     | Values        | Unit |
|---|------------|---------------|------|
| Chip or operating temperature                         | $T_j$      | -55 ... + 150 | °C   |
| Storage temperature                                   | $T_{stg}$  | -55 ... + 150 |      |
| Thermal resistance, chip to ambient air <sup>1)</sup> | $R_{thJA}$ | ≤ 200         | K/W  |
| DIN humidity category, DIN 40 040                     |            | E             |      |
| IEC climatic category, DIN IEC 68-1                   |            | 55 / 150 / 56 |      |

## Electrical Characteristics, at $T_j = 25^\circ\text{C}$ , unless otherwise specified

| Parameter | Symbol | Values |      |      | Unit |
|-----------|--------|--------|------|------|------|
|           |        | min.   | typ. | max. |      |

## Static Characteristics

|  |               |             |                 |                   |    |
|--|---------------|-------------|-----------------|-------------------|----|
| Drain- source breakdown voltage<br>$V_{GS} = 0 \text{ V}$ , $I_D = -0.25 \text{ mA}$ , $T_j = 25^\circ\text{C}$  | $V_{(BR)DSS}$ | -50         | -               | -                 | V  |
| Gate threshold voltage<br>$V_{GS}=V_{DS}$ , $I_D = -1 \text{ mA}$  | $V_{GS(th)}$  | -0.8        | -1.5            | -2                |    |
| Zero gate voltage drain current<br>$V_{DS} = -50 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $T_j = 25^\circ\text{C}$<br>$V_{DS} = -50 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $T_j = 125^\circ\text{C}$<br>$V_{DS} = -25 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $T_j = 25^\circ\text{C}$ | $I_{DSS}$     | -<br>-<br>- | -0.1<br>-2<br>- | -1<br>-60<br>-0.1 | μA |
| Gate-source leakage current<br>$V_{GS} = -20 \text{ V}$ , $V_{DS} = 0 \text{ V}$   | $I_{GSS}$     | -           | -1              | -10               |    |
| Drain-Source on-state resistance<br>$V_{GS} = -10 \text{ V}$ , $I_D = -0.17 \text{ A}$   | $R_{DS(on)}$  | -           | 5.3             | 10                | Ω  |

## Electrical Characteristics, at $T_j = 25^\circ\text{C}$ , unless otherwise specified

| Parameter | Symbol | Values |      |      | Unit |
|-----------|--------|--------|------|------|------|
|           |        | min.   | typ. | max. |      |

### Dynamic Characteristics

|   |              |      |      |    |    |
|---|--------------|------|------|----|----|
| Transconductance<br>$V_{DS} \geq 2 \cdot I_D \cdot R_{DS(on)max}$ , $I_D = -0.17 \text{ A}$                               | $g_{fs}$     | 0.05 | 0.09 | -  | S  |
| Input capacitance<br>$V_{GS} = 0 \text{ V}$ , $V_{DS} = -25 \text{ V}$ , $f = 1 \text{ MHz}$                              | $C_{iss}$    | -    | 30   | 40 | pF |
| Output capacitance<br>$V_{GS} = 0 \text{ V}$ , $V_{DS} = -25 \text{ V}$ , $f = 1 \text{ MHz}$                             | $C_{oss}$    | -    | 17   | 25 |    |
| Reverse transfer capacitance<br>$V_{GS} = 0 \text{ V}$ , $V_{DS} = -25 \text{ V}$ , $f = 1 \text{ MHz}$                   | $C_{rss}$    | -    | 8    | 12 |    |
| Turn-on delay time<br>$V_{DD} = -30 \text{ V}$ , $V_{GS} = -10 \text{ V}$ , $I_D = -0.27 \text{ A}$<br>$R_G = 50 \Omega$  | $t_{d(on)}$  | -    | 7    | 10 | ns |
| Rise time<br>$V_{DD} = -30 \text{ V}$ , $V_{GS} = -10 \text{ V}$ , $I_D = -0.27 \text{ A}$<br>$R_G = 50 \Omega$           | $t_r$        | -    | 12   | 18 |    |
| Turn-off delay time<br>$V_{DD} = -30 \text{ V}$ , $V_{GS} = -10 \text{ V}$ , $I_D = -0.27 \text{ A}$<br>$R_G = 50 \Omega$ | $t_{d(off)}$ | -    | 10   | 13 |    |
| Fall time<br>$V_{DD} = -30 \text{ V}$ , $V_{GS} = -10 \text{ V}$ , $I_D = -0.27 \text{ A}$<br>$R_G = 50 \Omega$           | $t_f$        | -    | 20   | 27 |    |

### Electrical Characteristics, at $T_j = 25^\circ\text{C}$ , unless otherwise specified

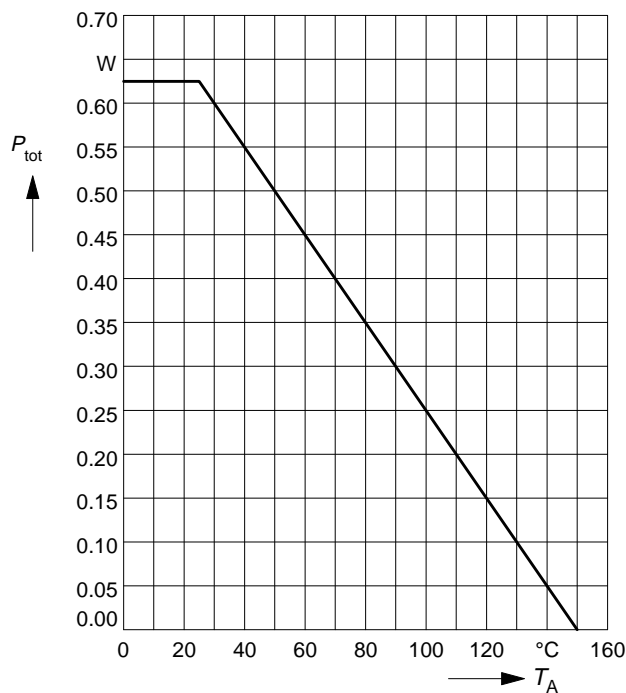
| Parameter | Symbol | Values |      |      | Unit |
|-----------|--------|--------|------|------|------|
|           |        | min.   | typ. | max. |      |

#### Reverse Diode

|  |          |   |       |       |   |
|--|----------|---|-------|-------|---|
| Inverse diode continuous forward current<br>$T_A = 25^\circ\text{C}$         | $I_S$    | - | -     | -0.17 | A |
| Inverse diode direct current,pulsed<br>$T_A = 25^\circ\text{C}$              | $I_{SM}$ | - | -     | -0.68 |   |
| Inverse diode forward voltage<br>$V_{GS} = 0\text{ V}, I_F = -0.34\text{ A}$ | $V_{SD}$ | - | -0.95 | -1.2  | V |

## Power dissipation

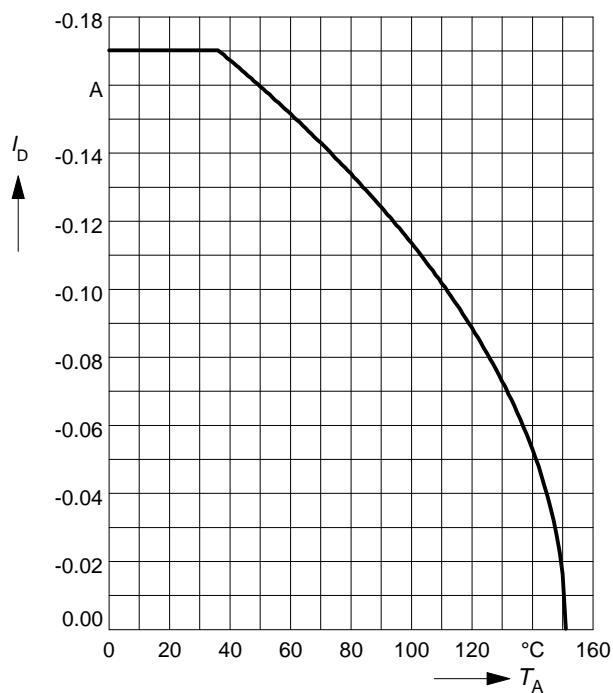
$$P_{\text{tot}} = f(T_A)$$



## Drain current

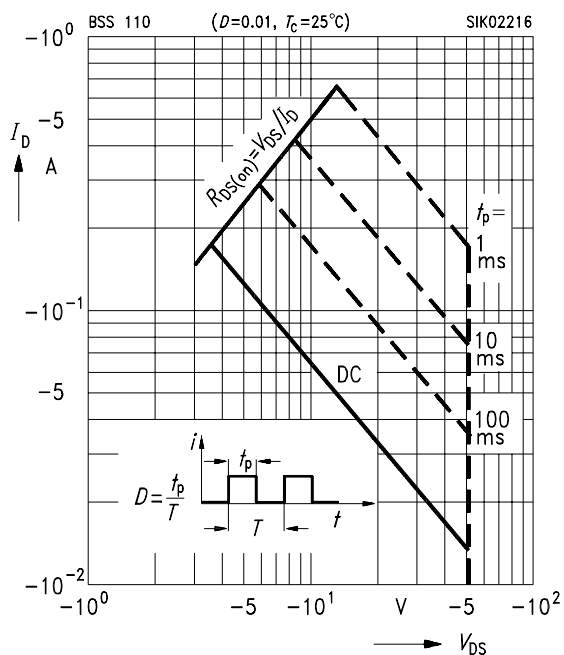
$$I_D = f(T_A)$$

parameter:  $V_{GS} \geq -10$  V



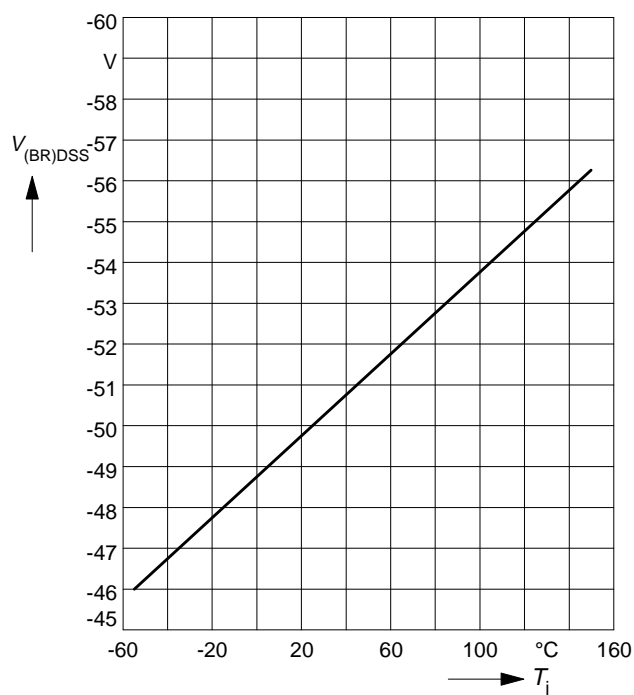
## Safe operating area $I_D = f(V_{DS})$

parameter :  $D = 0.01$ ,  $T_C = 25^\circ\text{C}$



## Drain-source breakdown voltage

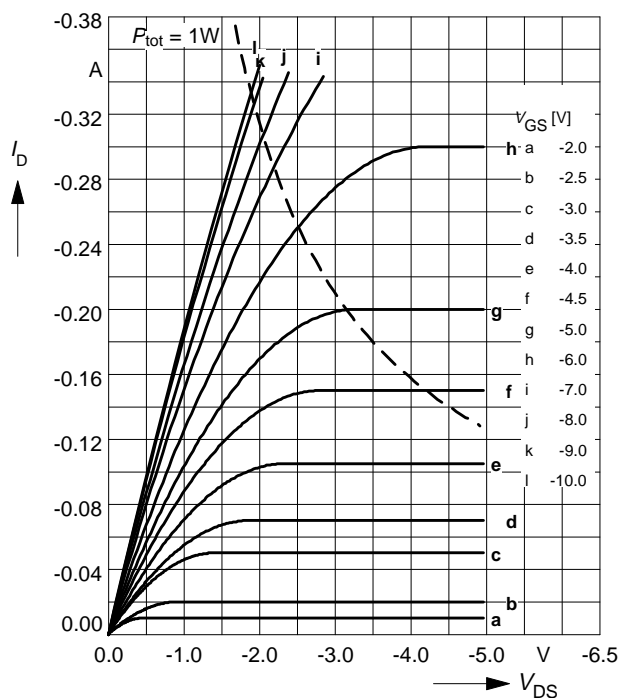
$$V_{(BR)DSS} = f(T_j)$$



## Typ. output characteristics

$$I_D = f(V_{DS})$$

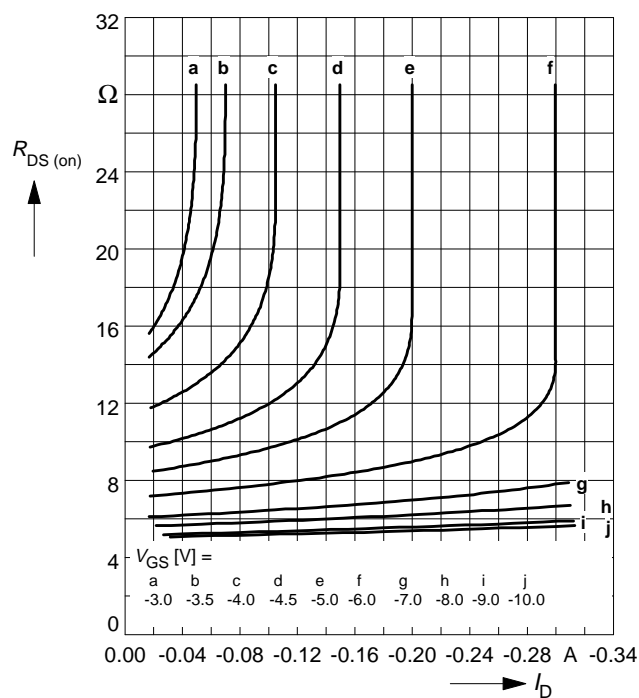
parameter:  $t_p = 80 \mu s$



## Typ. drain-source on-resistance

$$R_{DS(on)} = f(I_D)$$

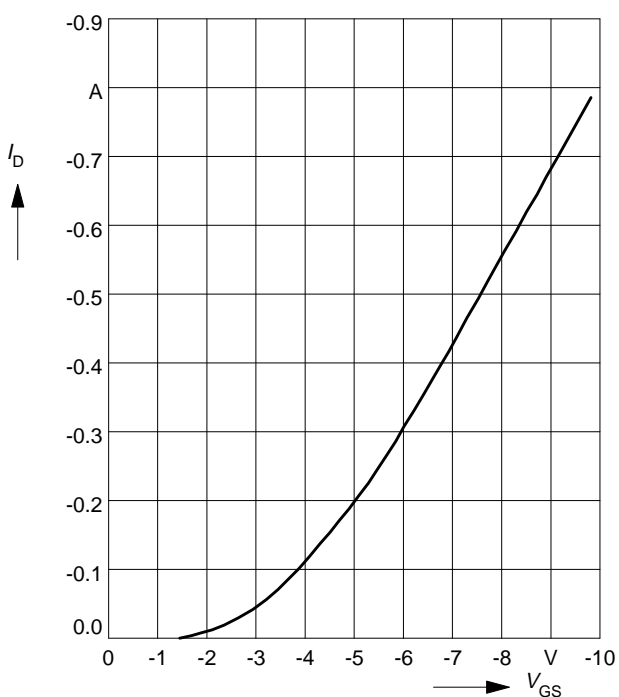
parameter:  $t_p = 80 \mu s$ ,  $T_j = 25^\circ C$



## Typ. transfer characteristics $I_D = f(V_{GS})$

parameter:  $t_p = 80 \mu s$

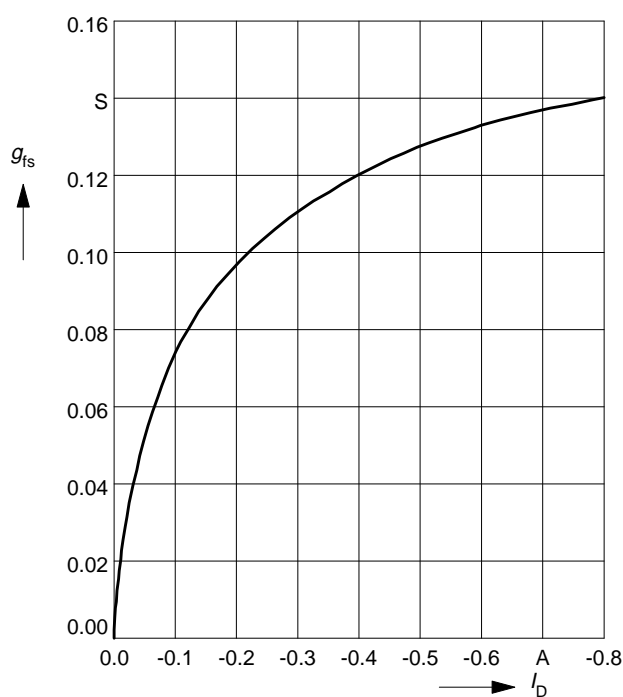
$$V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$$



## Typ. forward transconductance $g_{fs} = f(I_D)$

parameter:  $t_p = 80 \mu s$ ,

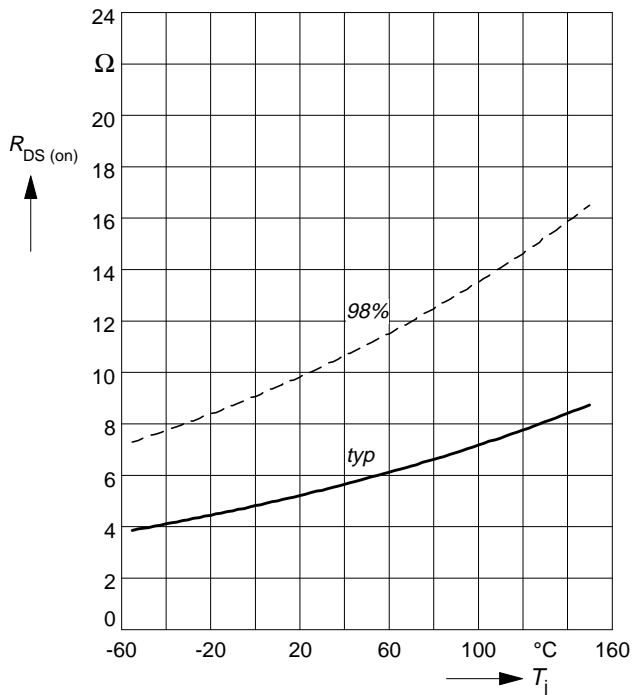
$$V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$$



## Drain-source on-resistance

$$R_{DS(on)} = f(T_j)$$

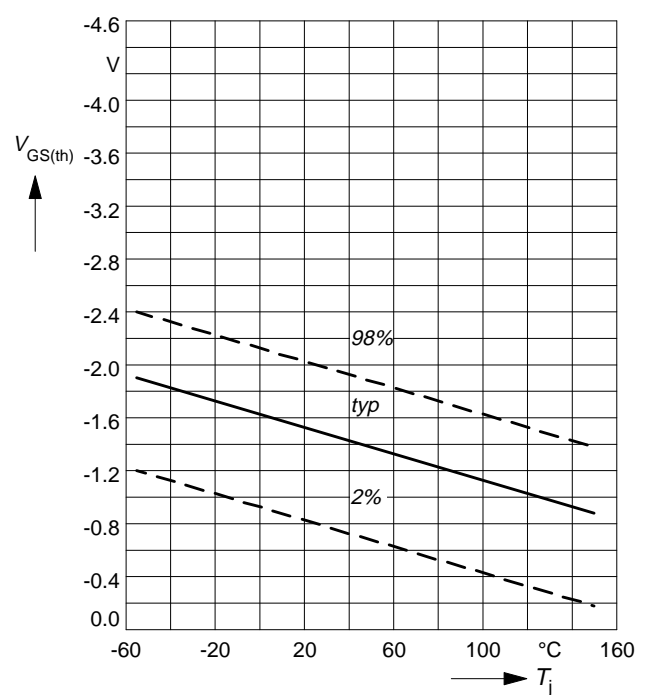
parameter:  $I_D = -0.17$  A,  $V_{GS} = -10$  V



## Gate threshold voltage

$$V_{GS(th)} = f(T_j)$$

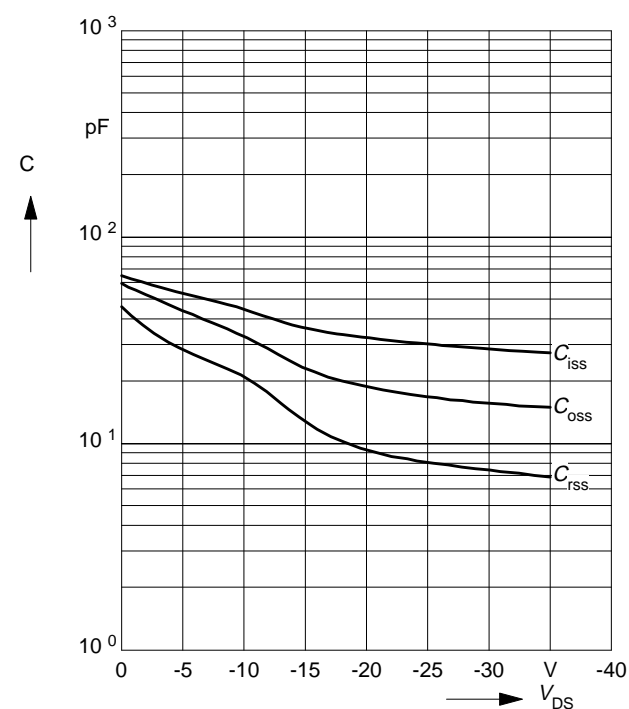
parameter:  $V_{GS} = V_{DS}$ ,  $I_D = -1$  mA



## Typ. capacitances

$$C = f(V_{DS})$$

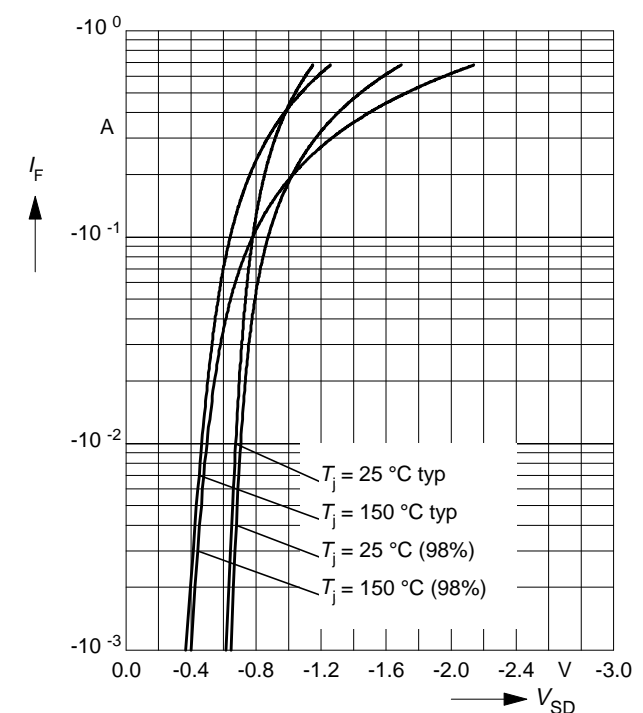
parameter:  $V_{GS} = 0$  V,  $f = 1$  MHz



## Forward characteristics of reverse diode

$$I_F = f(V_{SD})$$

parameter:  $T_j$ ,  $t_p = 80$   $\mu\text{s}$



This datasheet has been download from:

[www.datasheetcatalog.com](http://www.datasheetcatalog.com)

Datasheets for electronics components.